

62mm Module with low loss IGBT and Fast recovery diode.

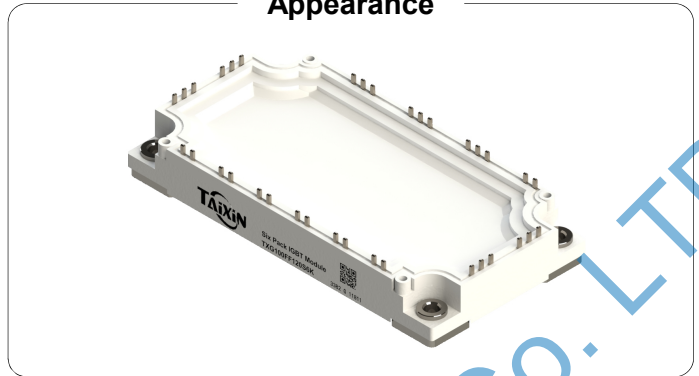
Feature

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- Maximum junction temperature 175 $^{\circ}$ C

Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Appearance



Maximum Ratings of Inverter IGBT ($T_{vj}=25^{\circ}$ C unless otherwise noted)

Items	Symbol	Conditions	Maximum Rating	Units
Collector-emitter voltage	V_{CES}		1200	V
Gate-emitter voltage	V_{GES}		± 30	V
Collector current	I_C	$T_{vj}=25^{\circ}$ C	200	A
		$T_{vj}=100^{\circ}$ C	100	A
Pulsed collector current	I_{CM}	$t_p=1ms$	200	A
Short circuit current	I_{sc}	$V_{GE} \leq 15V, V_{CC}=600V, t_p=10\mu s$ $V_{CEmax}=V_{CES}-L_s \cdot di/dt$	450	A
Maximum power dissipation	P_D	$T_c=25^{\circ}$ C, $T_{vj}=150^{\circ}$ C	510	W

Electrical Characteristics of Inverter IGBT ($T_{vj}=25^{\circ}$ C unless otherwise noted)

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Collector-emitter breakdown voltage	V_{CES}	$V_{GE}=0V, I_C=1mA$	1200			V
Collector -emitter leakage current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V$			1.0	mA
Gate leakage current, forward	I_{GES}	$V_{GE}=20V, V_{CE}=0V$			100	nA
		$V_{GE}=-20V, V_{CE}=0V$			-100	nA
Gate threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=24mA$	5.0	5.2	7.0	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=100A, T_{vj}=25^{\circ}$ C		1.85		V
		$V_{GE}=15V, I_C=100A, T_{vj}=125^{\circ}$ C		2.05		V
Integrated gate resistor	R_{Gint}	$f=1M; V_{pp}=1V$		0.0		Ω
Input capacitance	C_{ies}	$V_{CE}=25V$		6.30		nF
Output capacitance	C_{oes}	$V_{GE}=0V$		0.05		nF
Reverse transfer capacitance	C_{res}	$f=1MHz$		0.27		nF
Total gate charge	Q_g	$V_{CC}=600V, V_{GE}=15V, I_C=25A$		800		μ C
Turn-on delay time	$t_{d(on)}$	$V_{CC}=600V$		135		ns
Rise time	t_r	$V_{GE}=\pm 15V$		30		ns
Turn-off delay time	$t_{d(off)}$	$I_C=100A$		310		ns
Fall time	t_f	$R_G=2.2\Omega$		50		ns
Turn-on energy loss per pulse	E_{on}	Inductive Load $T_{vj}=25^{\circ}$ C		7.30		mJ
Turn-off energy loss per pulse	E_{off}			5.50		mJ
Turn-on delay time	$t_{d(on)}$	$V_{CC}=600V$		160		ns
Rise time	t_r	$V_{GE}=\pm 15V$		35		ns
Turn-off delay time	$t_{d(off)}$	$I_C=100A$		400		ns
Fall time	t_f	$R_G=2.2\Omega$		85		ns
Turn-on energy loss per pulse	E_{on}	Inductive Load $T_{vj}=25^{\circ}$ C		10.0		mJ
Turn-off energy loss per pulse	E_{off}			8.50		mJ
Temperature under switching conditions	$T_{vj op}$		-55		150	$^{\circ}$ C

Maximum Ratings of Inverter Diode

Items	Symbol	Conditions	Maximum Rating	Units
Repetitive peak reverse voltage	V_{RRM}	$T_{vj}=25^{\circ}C$	1200	V
Diode continuous forward current	I_F	$T_{vj}=25^{\circ}C$	200	A
		$T_{vj}=100^{\circ}C$	100	A
Diode maximum forward current	I_{FM}	$t_p=1ms, T_{vj}=25^{\circ}C$	200	A

Electrical Characteristics of Inverter Diode ($T_{vj}=25^{\circ}C$ unless otherwise noted)

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Diode forward voltage	V_F	$I_F=100A, T_{vj}=25^{\circ}C$		2.10		V
		$I_F=100A, T_{vj}=125^{\circ}C$		2.20		V
Diode peak reverse recovery current	I_{rr}	$V_{CE}=600V, I_F=100A$		136		A
Diode reverse recovery charge	Q_{rr}	$dI_F/dt=2000A/\mu s$		12.1		μC
Reverse recovery energy	E_{rec}	$T_{vj}=25^{\circ}C$		4.10		mJ
Diode peak reverse recovery current	I_{rr}	$V_{CE}=600V, I_F=100A$		195		A
Diode reverse recovery charge	Q_{rr}	$dI_F/dt=2000A/\mu s$		24.6		nC
Reverse recovery energy	E_{rec}	$T_{vj}=25^{\circ}C$		7.50		mJ

Characteristics of NTC ($T_{vj}=25^{\circ}C$ unless otherwise noted)

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Rated resistance	R_{25}			5.00		
Deviation of R100	$\Delta R/R$	$T_C = 100^{\circ}C, R_{100} = 493 W$	-5		5	%
Power dissipation	P_{25}				20.0	mW
B-value	$B_{25/50}$	$R_2=R_{25} \exp [B_{25/50}(1/T_2-1/(298,15 K))]$		3375		K
B-value	$B_{25/80}$	$R_2=R_{25} \exp [B_{25/80}(1/T_2-1/(298,15 K))]$		3411		K
B-value	$B_{25/100}$	$R_2=R_{25} \exp [B_{25/100}(1/T_2-1/(298,15 K))]$		3433		K

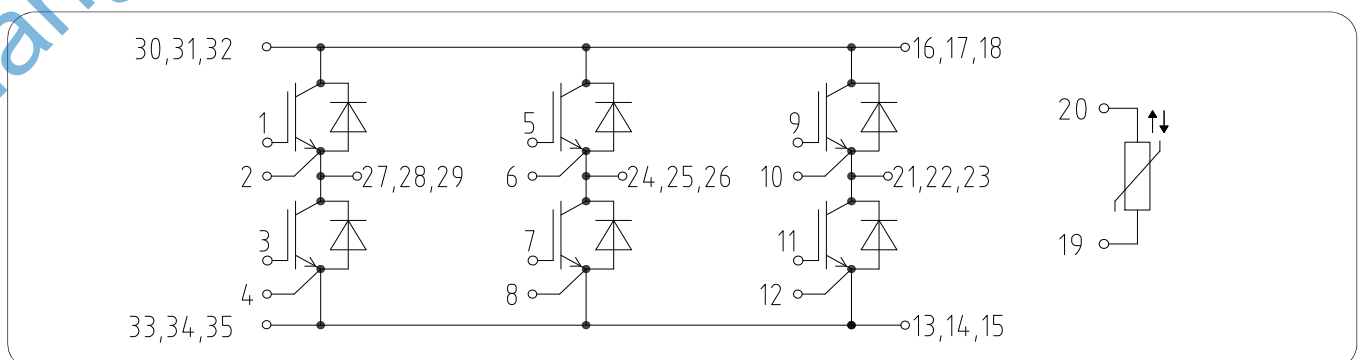
Thermal Characteristics

Items	Symbol	Min.	typ.	Max.	Units
Thermal resistance, junction to case for IGBT	$R_{th j-c}$		0.30		$^{\circ}C/W$
Thermal resistance, junction to case for Diode	$R_{th j-c}$		0.50		$^{\circ}C/W$
Thermal resistance, case to sink	$R_{th C-S}$		0.02		$^{\circ}C/W$

Module Characteristics

Items	Symbol	Conditions	Min.	typ.	Max.	Units
Material of module baseplate				Cu		
Internal isolation		terminal to terminal		Al_2O_3		
Isolation test voltage	V_{isol}	RMS, $f = 50 Hz, t = 1 min.$	2.5			kV
Stray inductance module	L_{sCE}			30		nH
Mounting torque for modul mounting	M	Screw M6	3.0		5.0	Nm
Storage temperature range	T_{STG}		-55		150	$^{\circ}C$
Weight of Module	W_t			185		g

Internal Circuit:



Representative Characteristics

Fig 1. Output characteristic IGBT
 $I_C=f(V_{CE}), V_{GE}=15V$

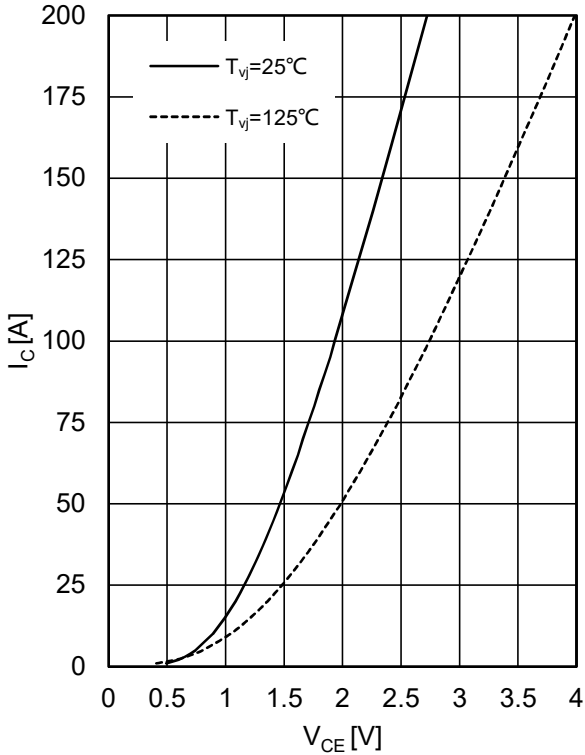


Fig 2. Output characteristic IGBT
 $I_C=f(V_{CE})$
 $T_{vj}=125^\circ C$

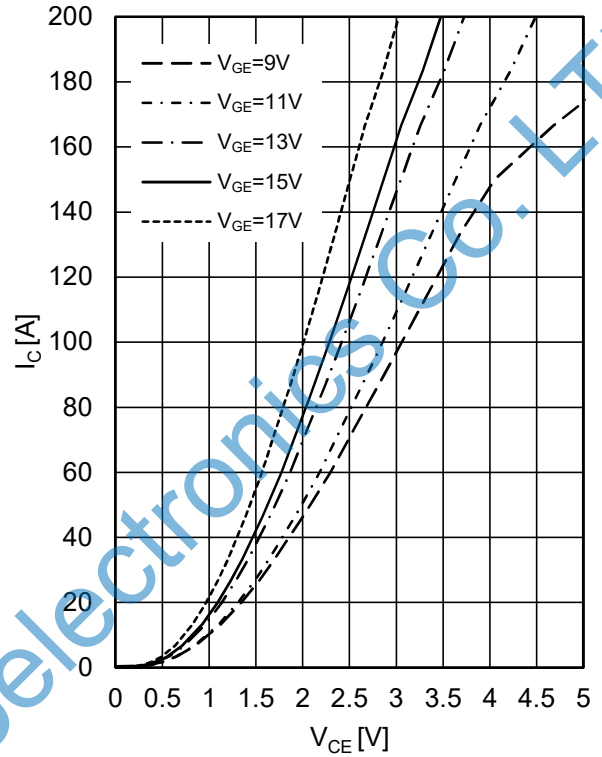


Fig 3. Transfer characteristic IGBT
 $I_C=f(V_{GE})$
 $V_{CE}=20V$

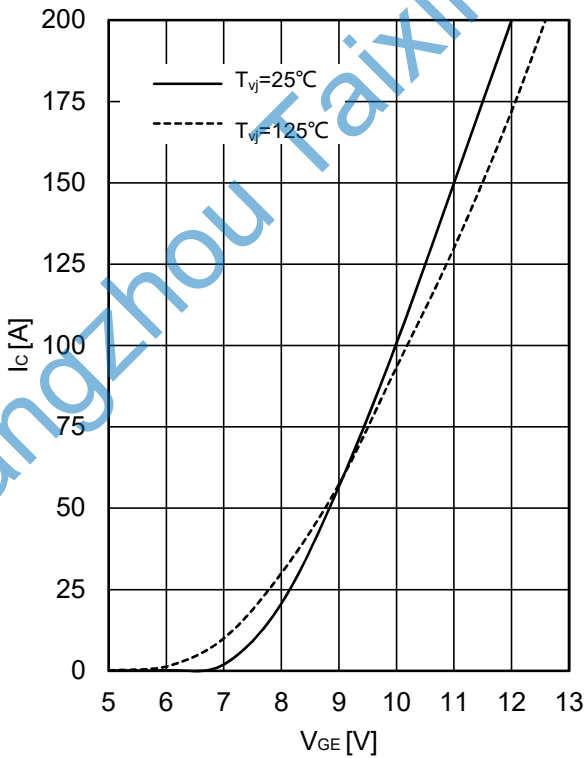


Fig 4. Switching losses IGBT
 $E_{on}=f(I_C), E_{off}=f(I_C)$
 $V_{GE}=\pm 15V, R_G=2\Omega, V_{CE}=600V$

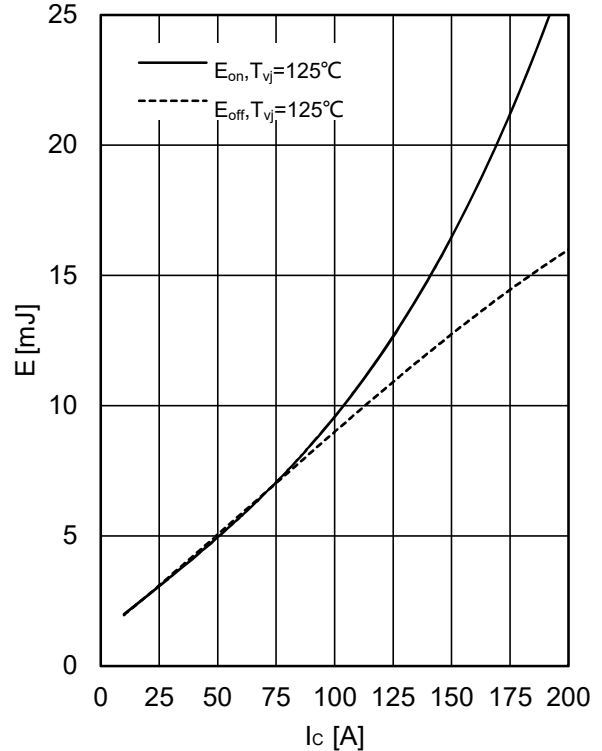


Fig 5. Switching losses IGBT

$$E_{on}=f(R_G), E_{off}=f(R_G),$$

$$V_{GE}=\pm 15V, I_C=100A, V_{CE}=600V$$

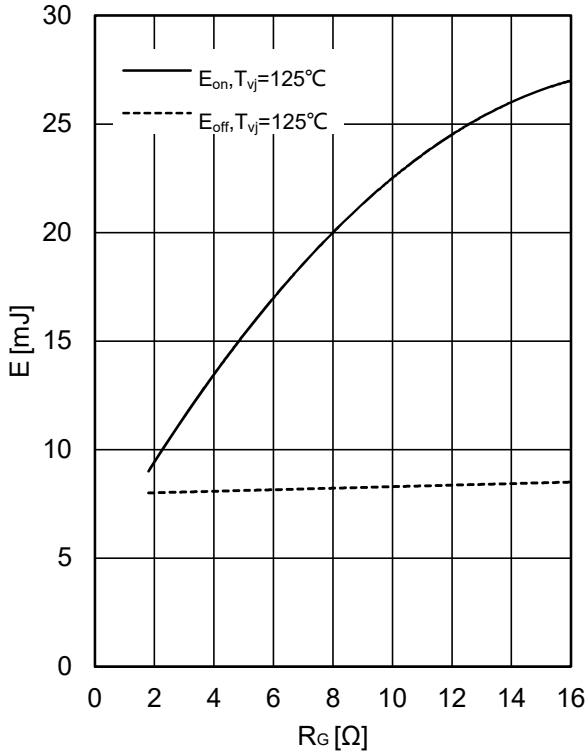


Fig 6. Transient thermal impedance IGBT

$$Z_{thjc}=f(t)$$

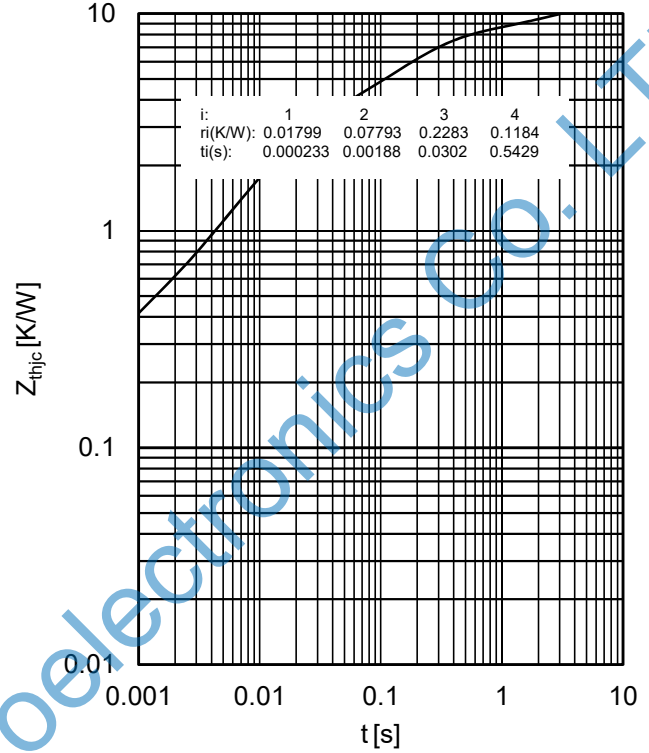


Fig 7. Reverse bias safe operating area IGBT,

$$I_C=f(V_{CE})$$

$$V_{GE}=\pm 15V, R_{Goff}=2\Omega, T_{vj}=125^\circ C$$

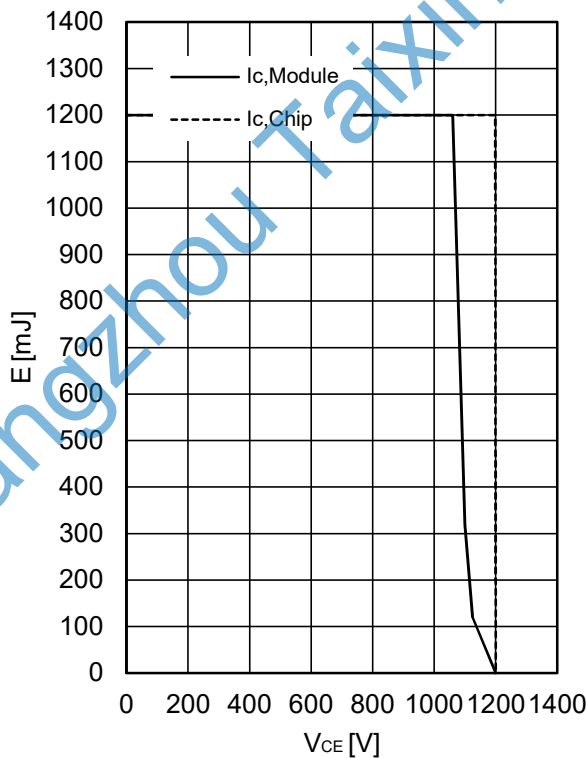


Fig 8. Forward characteristic of Diode

$$I_F=f(V_F)$$

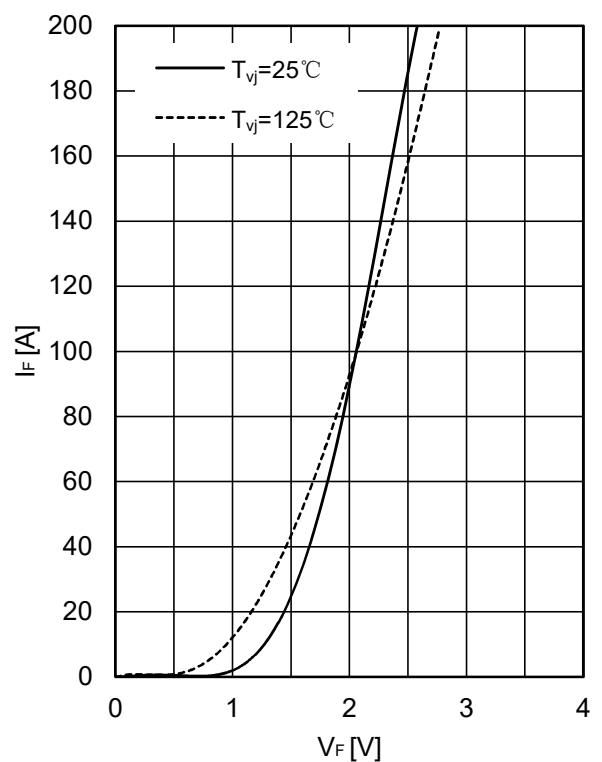


Fig 9. Switching losses Diode

$E_{rec}=f(I_F)$
 $R_G=2\Omega, V_{CE}=600V$

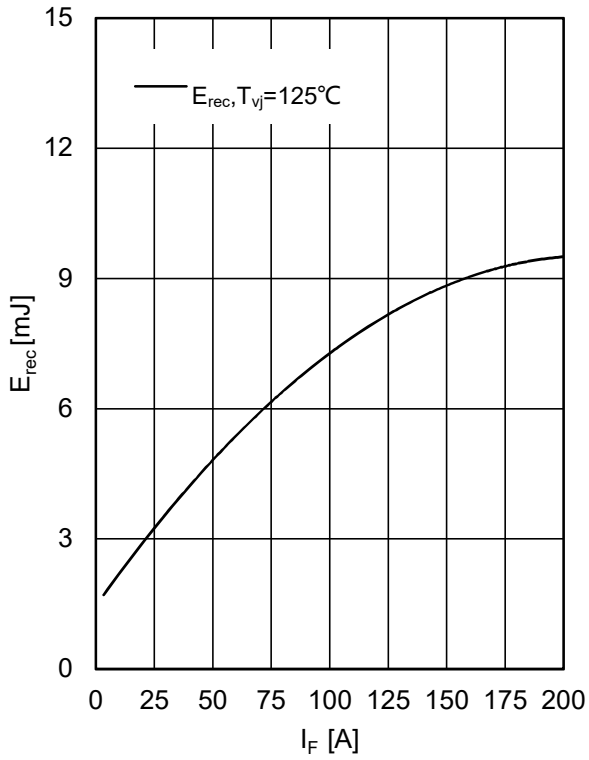
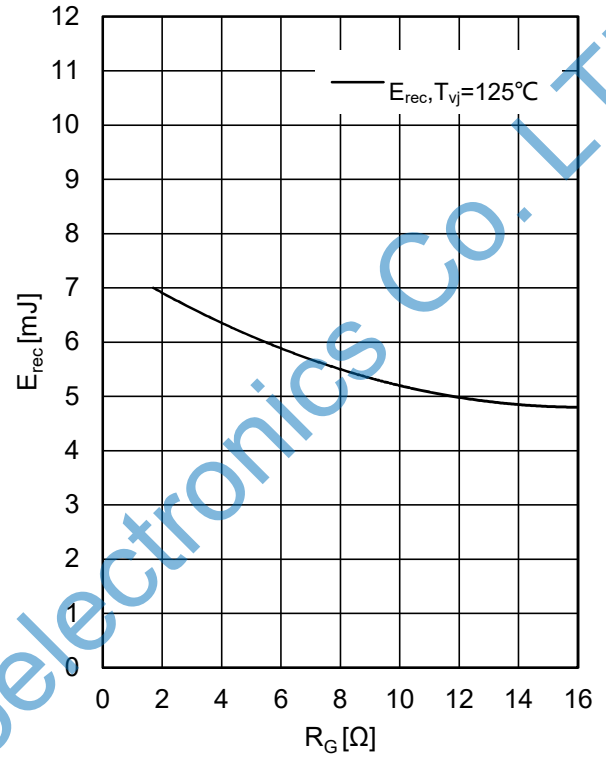


Fig 10. Switching losses Diode

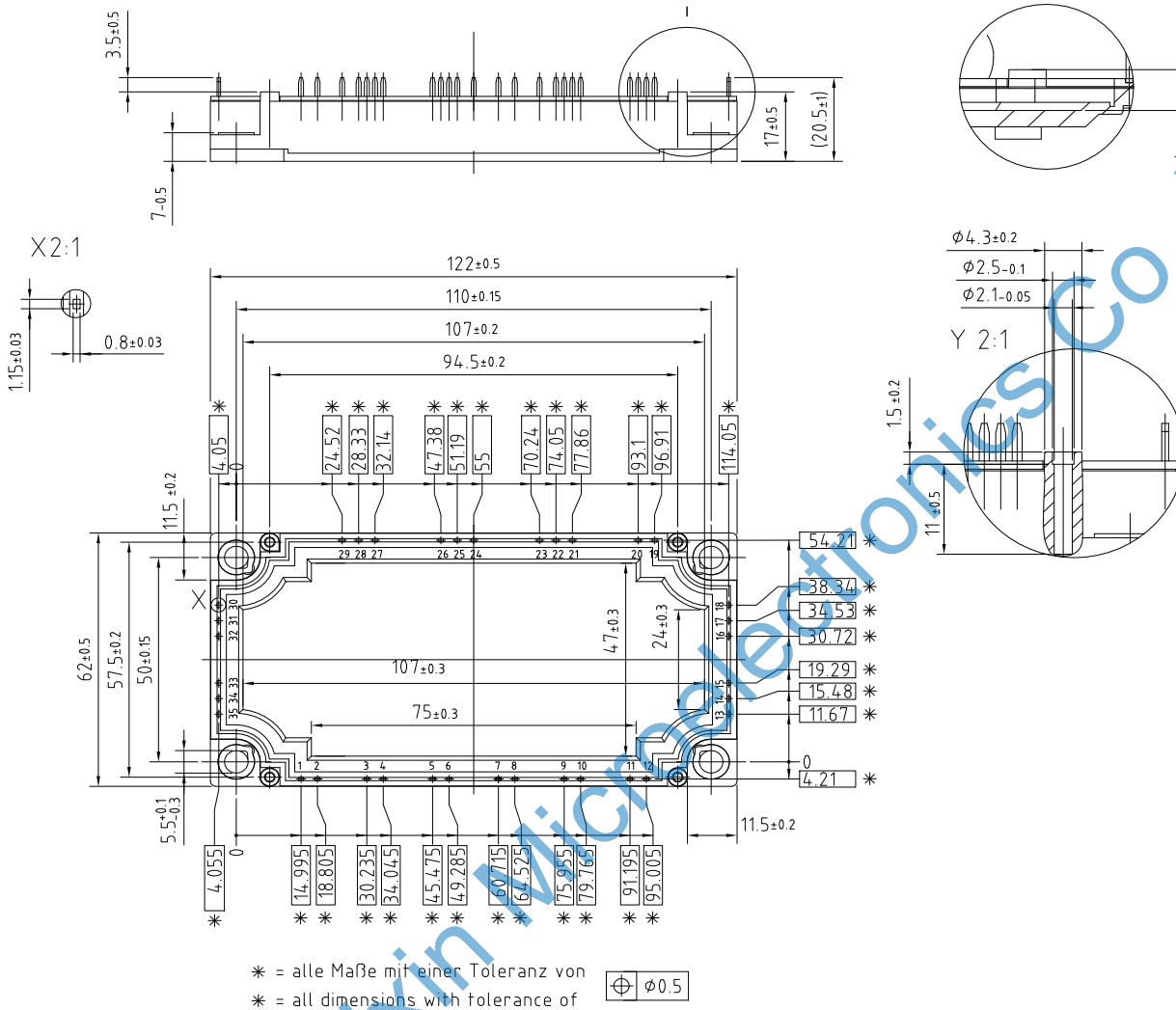
$E_{rec}=f(R_G)$
 $I_F=100A, V_{CE}=600V$



Hangzhou Taixin Microelectronics Co., Ltd.

Package Dimensions

Dimensions in Millimeters



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